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U.S. Depa	artment	of Commerce, Pat	ent and Tradem	nark Office	Docke	t No.	Serial	No.		
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LIST OF F	PATEN	TS AND PUBLICA	TIONS CITED	APPLICANT	Applic	Applicant				
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/F.S./	A1	4,058,430	11/15/77	Suntola et al.	156	611	11/25/1	975		
/F.S./	A2	4,389,973	06/28/83	Suntola et al.	118	725	12/11/1	981		
/F.S./	А3	4,413,022	11/01/83	Suntola et al.	427	255.2	06/21/1	979		
/F.S./	A4	4,486,487	12/04/84	Skarp	428	216	04/25/1	983		
/F.S./	A5	4,767,494	08/30/88	Kobayashi et a	l. 156	606	09/19/1	986		
/F.S./	A6	4,806,321	02/21/89	Nishizawa et al	. 422	245	07/21/1	985		
/F.S./	A7	4,829,022	05/09/89	Kobayashi et a	l. 437	107	12/09/1	986		
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/F.S./	A9	4,838,983	06/13/89	Schumaker et al.	156	613	03/18/1	988		
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F.S./	A11	4,840,921	06/20/89	Matsumoto	437	89	06/30/1	988		
/F.S./	A12	4,845,049	07/04/89	Sunakawa	437	81	03/28/1	988		
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/F.S./_	B2	01/40541 A1	06/07/2001	wo	C23C	16/40		Х		
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/F.S./	C2	Klaus, et al., "Atomic Surface Review & Le			ed and Unca	atalyzed Self-Li	miting Surface	Reactions		
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LIST OF F	PATEN	TS AND PUBLICA	TIONS CITED	APPLICANT	Applica	ant	•	.,	
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/F.S./	A16	4,876,218	10/24/89	Pessa et al.	437	107	09/26/19	988	
/F.S./	A17	4,927,670	05/22/1990	Erbil	427	255.3	06/22/19	988	
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/F.S./	A21	4,993,357	02/19/91	Scholz	118	118 715		989	
/F.S./	A22	5,013,683	05/07/91	Petroff et al.	437	110	01/23/19	989	
/F.S./	A23	5,082,798	01/21/92	Arimoto	437	108	09/27/19	990	
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/F.S./	A25	5,091,320	02/25/92	Aspnes et al.	437	8	06/15/19	990	
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/F.S./	A41	5,316,615	05/31/94	Copel	117	95	03/09/19	993
/F.S./	A42	5,316,793	05/31/94	Wallace et al.	427	248.1	07/27/19	992
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/F.S./	A50	5,439,876	08/08/95	Graf et al.	505	447	08/16/19	993
/F.S./	A51	5,441,703	08/15/95	Jurgensen	422	129	03/29/19	994
/F.S./	A52	5,443,033	08/22/95	22/95 Nishizawa et al.		86	03/11/19	994
/F.S./	A53	5,443,647	08/22/95	Aucoin et al.	118	723 ME	07/11/19	994
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/F.S./	B14	00/16377 A2	03/23/2000	wo	H01L		-	X
/F.S./	B15	00/15881 A2	03/23/2000	wo	C30B			X
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/F.S./	A55	5,458,084	10/17/95	Thorne et al.	117	89	12/09/1	993			
/F.S./	A56	5,469,806	11/28/95	Mochizuki et al	. 117	97	08/20/1	993			
/F.S./	A57	5,480,818	01/02/96	Matsumoto et al.	437	40	02/09/1	993			
/F.S./	A58	5,483,919	01/16/96	Yokoyama et al.	117	89	08/17/1	994			
/F.S./	A59	5,484,664	01/16/96	Kitahara et al.	428	641	01/21/1	994			
/F.S./	A60	5,503,875	04/02/96	Imai et al.	427	255.3	03/17/1	994			
/F.S./	A61	5,521,126	05/28/96	Okamura et al.	437	235	06/22/1	994			
/F.S./	A62	5,527,733	06/18/96	Nishizawa et al	l. 437	160	02/18/1	02/18/1994			
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/F.S./	A64	5,540,783	07/30/96	Eres et al.	118	. 725	05/26/1	994			
/F.S./	A65	5,601,651	02/11/97	Watabe	118	715	12/14/1	994			
/F.S./	A66	5,616,181	04/01/97	Yamamoto et al.	118	723 EF	11/21/1	995			
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/F.S./	A68	5,641,984	06/24/97	Aftergut et al.	257	433	08/19/19	994
/F.S./	A69	5,644,128	07/01/97	Wollnik et al.	250	251	08/25/19	994
/F.S./	A70	5,693,139	12/02/97	Nishizawa et al	. 117	89	06/15/19	993
/F.S./	A71	5,705,224	01/06/98	Murota et al.	427	248.1	01/31/19	995
/F.S./	A72	5,707,880	01/13/98	Aftergut et al.	437	3	01/17/19	997
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/F.S./	A79	5,830,270	11/03/98	McKee et al.	117	106	08/05/19	996
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